

# YIBO LIN

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PhD student  $\diamond$  Department of Electrical & Computer Engineering

## RESEARCH INTERESTS

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Nanometer IC design for manufacturability, modeling and optimization in VLSI CAD

## EDUCATION

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### University of Texas at Austin, TX, USA

*Aug. 2013 – Present*

Ph.D. student, Department of Electrical and Computer Engineering

Advisor: David Z. Pan

(GPA 3.96/4.0)

### Shanghai Jiao Tong University, Shanghai, P.R.China

*Sep. 2009 – Jun. 2013*

B.S., Department of Microelectronics

(GPA 91.17/100)

(Rank top 1/60)

## EXPERIENCE

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### IMEC, Leuven, Belgium

*Sep. 2016 – Nov. 2016*

Internship

Design technology co-optimization for emerging lithography options

### Chinese University of Hong Kong, China

*Jun. 2016 – Aug. 2016*

Summer Intern

Quantum computing

### Cadence Design System, TX, USA

*May 2015 – Aug. 2015*

Summer Intern

Routability driven detailed placement

### Oracle Inc., TX, USA

*May 2014 – Aug. 2014*

Summer Intern

Incremental timing driven detailed placement

### ECE Department, University of Texas at Austin, TX, USA

*Jan. 2014 – Present*

Graduate Research Assistant

Multiple patterning lithography layout decomposition

Stitch aware detailed placement

Triple-patterning aware detailed placement

Dummy fill insertion

Detailed-routing-driven placement

## PUBLICATIONS

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### Journal Papers

- [J5] **Yibo Lin**, Bei Yu, Biying Xu and David Z. Pan, “Triple patterning aware detailed placement toward zero cross-row middle-of-line conflict”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), 2017.
- [J4] **Yibo Lin**, Bei Yu, Yi Zou, Zhuo Li, Charles J Alpert and David Z. Pan, “Stitch aware detailed placement for multiple e-beam lithography”, Integration, the VLSI Journal, 2017. (to appear)
- [J3] **Yibo Lin**, Bei Yu and David Z. Pan, “High performance dummy fill insertion with coupling and uniformity constraints”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), Dec, 2016.

- [J2] Bei Yu, Xiaoqing Xu, Subhendu Roy, **Yibo Lin**, Jiaojiao Ou and David Z. Pan, “Design for manufacturability and reliability in extreme-scaling VLSI”, Science China Information Sciences, 2016. (**Invited paper**)
- [J1] Bei Yu, Xiaoqing Xu, Jih-Rong Gao, **Yibo Lin**, Zhuo Li, Charles Alpert and David Z. Pan, “Methodology for standard cell compliance and detailed placement for triple patterning lithography”, IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD), May, 2015.

### Conference Papers

- [C9] Jiaojiao Ou, Bei Yu, Xiaoqing Xu, Joydeep Mitra, **Yibo Lin** and David Z. Pan, “DSAR: DSA aware routing with simultaneous DSA guiding pattern and double patterning assignment”, ACM International Symposium on Physical Design (ISPD), Portland, OR, Mar 19-22, 2017. (to appear)
- [C8] **Yibo Lin**, Bei Yu, Xiaoqing Xu, Jih-Rong Gao, Natarajan Viswanathan, Wen-Hao Liu, Zhuo Li, Charles J Alpert and David Z. Pan, “MrDP: Multiple-row detailed placement of heterogeneous-sized cells for advanced nodes”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Austin, TX, Nov 7-10, 2016.
- [C7] Yudong Tao, Changhao Yan, **Yibo Lin**, Sheng-Guo Wang, David Z. Pan and Xuan Zeng, “A novel unified dummy fill insertion framework with SQP-based optimization method”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Austin, TX, Nov 7-10, 2016.
- [C6] **Yibo Lin**, Bei Yu and David Z. Pan, “Detailed placement in advanced technology nodes: a survey”, IEEE International Conference on Solid-State and Integrated Circuit Technology (ICSICT), Hangzhou, China, Oct 25-28, 2016. (**Invited paper**)
- [C5] **Yibo Lin**, Xiaoqing Xu, Bei Yu, Ross Baldick and David Z. Pan, “Triple/quadruple patterning layout decomposition via novel linear programming and iterative rounding”, Proceedings of SPIE, San Jose, CA, Feb 21-25, 2016. (**Best Student Paper Award**)
- [C4] **Yibo Lin**, Bei Yu, Yi Zou, Zhuo Li, Charles J Alpert and David Z. Pan, “Stitch aware detailed placement for multiple e-beam lithography”, IEEE/ACM Asia and South Pacific Design Automation Conference (ASPDAC), Macau, China, Jan 25-28, 2016.
- [C3] **Yibo Lin**, Bei Yu, Biying Xu and David Z. Pan, “Triple patterning aware detailed placement toward zero cross-row middle-of-line conflict”, IEEE/ACM International Conference on Computer-Aided Design (ICCAD), Austin, TX, Nov 2-6, 2015.
- [C2] **Yibo Lin**, Bei Yu and David Z. Pan, “High performance dummy fill insertion with coupling and uniformity constraints”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Jun 7-11, 2015.
- [C1] David Z. Pan, Lars Liebmann, Bei Yu, Xiaoqing Xu and **Yibo Lin**, “Pushing multiple patterning in sub-10nm: are we ready?”, ACM/IEEE Design Automation Conference (DAC), San Francisco, CA, Jun 7-11, 2015. (**Invited Paper**)

### RELATED COURSES

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• EE382M: VLSI I	<i>Prof. Michael Orshansky</i>
• EE382N: Computer Architecture	<i>Prof. Aater Suleman</i>
• EE382V: Optimization Issues in VLSI CAD	<i>Prof. David Pan</i>
• EE382M: VLSI II	<i>Prof. Jacob Abraham</i>
• EE380L: Engineer Programming Languages	<i>Prof. Craig Chase</i>
• EE382V: Nanometer Scale IC Design	<i>Prof. Michael Orshansky</i>
• EE382V: VLSI Physical Design Automation	<i>Prof. David Pan</i>
• EE381V: Advanced Algorithms	<i>Prof. Evdokia Nikolova</i>
• EE382V: Advanced Programming Tools	<i>Prof. Aziz Adnan</i>
• EE380N: Optimization in Engineering Systems	<i>Prof. Ross Baldick</i>
• CS383C: Numerical Analysis: Linear Algebra	<i>Prof. Robert van de Geijn</i>

## SKILLS

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### Programming Languages

C/C++, Python, Verilog

### Web Development

HTML5, JavaScript/jQuery

### EDA Tools

Cadence Virtuoso, Synopsys Design Compiler, Synopsys IC Compiler

## AWARDS AND HONORS

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Franco Cerrina Memorial Best Student Paper Award	SPIE	2016
A. Richard Newton Young Student Fellow	DAC	2014
National Scholarship	Shanghai Jiao Tong University	2012
Samsung Scholarship	Shanghai Jiao Tong University	2011
The Second Prize Scholarship	Shanghai Jiao Tong University	2010